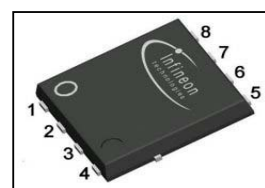
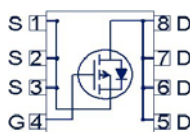


OptiMOS® -P Power-Transistor
Features

- P-Channel
- Enhancement mode
- Logic level
- 150°C operating temperature
- Avalanche rated
- V_{gs}=25V, specially suited for notebook applications


Product Summary

V_{DS}	-30	V
$R_{DS(on),max}$	8	mΩ
I_D	-30	A

PG-TDSON-8


Type	Package	Marking	Lead free	Packing
BSC080P03LS G	PG-TDSON-8	080P03LS	Yes	Dry

Maximum ratings, at $T_j=25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Continuous drain current	I_D	$T_C=25\text{ °C}$	-30	A
		$T_C=70\text{ °C}$	-30	
		$T_A=25\text{ °C}^{(1)}$	-16	
Pulsed drain current	$I_{D,pulse}$	$T_C=25\text{ °C}^{(2)}$	-120	
Avalanche energy, single pulse	E_{AS}	$I_D=-30\text{ A}, R_{GS}=25\text{ }\Omega$	248	mJ
Gate source voltage	V_{GS}		± 25	V
Power dissipation	P_{tot}	$T_C=25\text{ °C}$	89	W
		$T_A=25\text{ °C}^{(1)}$	2.8	
Operating and storage temperature	T_j, T_{stg}		-55 ... 150	°C
ESD class		JESD22-C101-HBM	1C (1kV-2kV)	
Soldering temperature			260 °C	
IEC climatic category; DIN IEC 68-1			55/150/56	

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	

Thermal characteristics

Thermal resistance, junction - case	R_{thJC}		-	-	1.4	K/W
Thermal resistance, junction - ambient	R_{thJA}	6 cm ² cooling area ¹⁾	-	-	50	

Electrical characteristics, at $T_j=25\text{ }^\circ\text{C}$, unless otherwise specified

Static characteristics

Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS}=0\text{ V}, I_D=-250\text{ }\mu\text{A}$	-30	-	-	V
Gate threshold voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=-250\text{ }\mu\text{A}$	-2.2	-1.5	-1	
Zero gate voltage drain current	I_{DSS}	$V_{DS}=-30\text{ V}, V_{GS}=0\text{ V}, T_j=25\text{ }^\circ\text{C}$	-	-0.1	-1	μA
		$V_{DS}=-30\text{ V}, V_{GS}=0\text{ V}, T_j=125\text{ }^\circ\text{C}$	-	-10	-100	
Gate-source leakage current	I_{GSS}	$V_{GS}=-25\text{ V}, V_{DS}=0\text{ V}$	-	-10	-100	nA
Drain-source on-state resistance	$R_{DS(on)}$	$V_{GS}=-10\text{ V}, I_D=-30\text{ A}$	-	6.1	8.0	m Ω
Gate resistance	R_G		-	4	-	Ω
Transconductance	g_{fs}	$ V_{DS} >2 I_D R_{DS(on)max}, I_D=-30\text{ A}$	30	60	-	S

¹⁾ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 μm thick) copper area for drain connection. PCB is vertical in still air.

²⁾ See Figure 3.

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	

Dynamic characteristics

Input capacitance	C_{iss}	$V_{GS}=0\text{ V}, V_{DS}=-15\text{ V},$ $f=1\text{ MHz}$	-	4620	6140	pF
Output capacitance	C_{oss}		-	1430	1900	
Reverse transfer capacitance	C_{rss}		-	1200	1800	
Turn-on delay time	$t_{d(on)}$	$V_{DD}=-15\text{ V}, V_{GS}=-$ $10\text{ V}, I_D=-30\text{ A},$ $R_G=6\ \Omega$	-	13.5	20.3	ns
Rise time	t_r		-	87.0	130.5	
Turn-off delay time	$t_{d(off)}$		-	79.0	118.5	
Fall time	t_f		-	108.0	162.0	

Gate Charge Characteristics³⁾

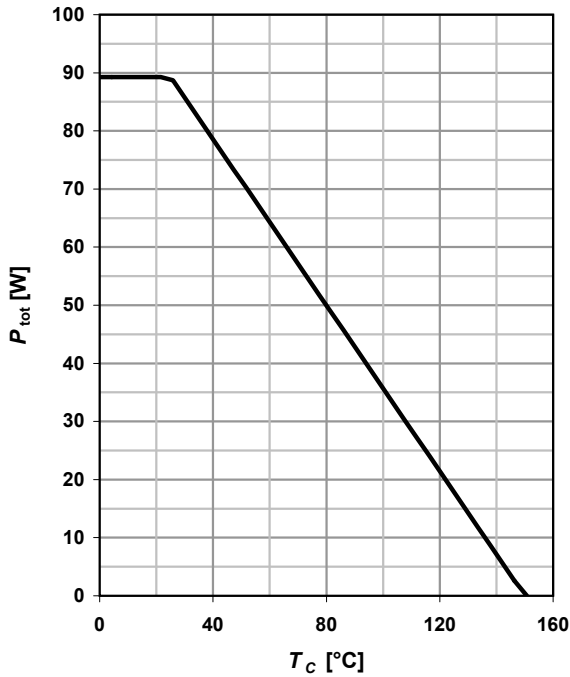
Gate to source charge	Q_{gs}	$V_{DD}=-24\text{ V}, I_D=30\text{ A},$ $V_{GS}=0\text{ to }-10\text{ V}$	-	-12.7	-16.8	nC
Gate charge at threshold	$Q_{g(th)}$		-	-7.1	-9.5	
Gate to drain charge	Q_{gd}		-	-34.3	-51.4	
Switching charge	Q_{sw}		-	-39.8	-58.8	
Gate charge total	Q_g		-	-92.0	-122.4	
Gate plateau voltage	$V_{plateau}$		-	-2.8	-	V
Output charge	Q_{oss}	$V_{DD}=-15\text{ V}, V_{GS}=0\text{ V}$	-	25.6	34.0	

Reverse Diode

Diode continuous forward current	I_S	$T_C=25\text{ }^\circ\text{C}$	-	-	30.0	A
Diode pulse current	$I_{S,pulse}$		-	-	-120	
Diode forward voltage	V_{SD}	$V_{GS}=0\text{ V}, I_F=-30\text{ A},$ $T_j=25\text{ }^\circ\text{C}$	-	-0.9	-1.2	V
Reverse recovery time	t_{rr}	$V_R=15\text{ V}, I_F= I_S ,$ $di_F/dt=100\text{ A}/\mu\text{s}$	-	35	44	ns
Reverse recovery charge	Q_{rr}		-	28.0	-	nC

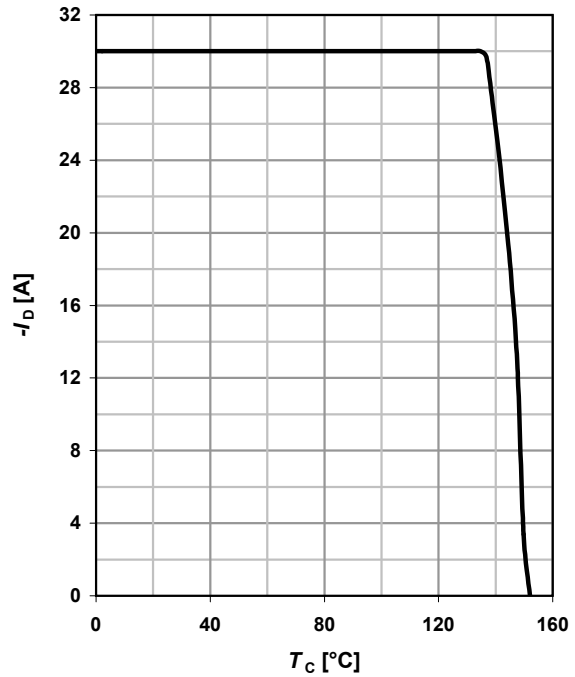
1 Power dissipation

$P_{tot}=f(T_C); t_p \leq 10 \text{ s}$



2 Drain current

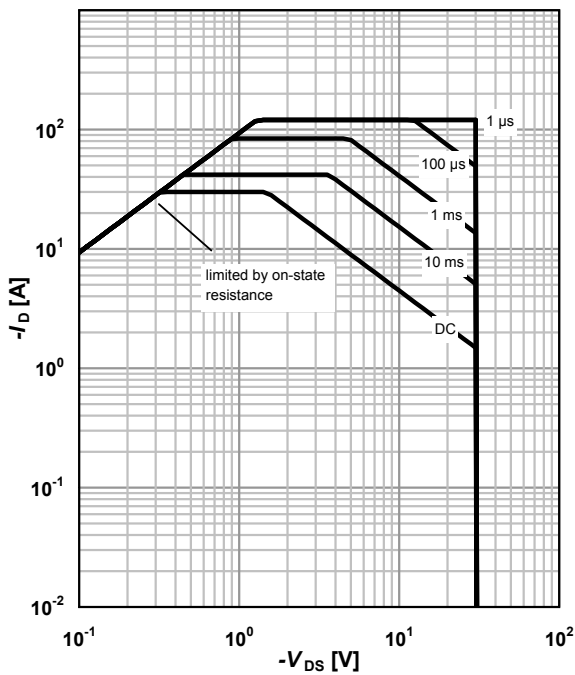
$I_D=f(T_C); |V_{GS}| \geq 10 \text{ V}; t_p \leq 10 \text{ s}$



3 Safe operating area

$I_D=f(V_{DS}); T_C=25 \text{ }^\circ\text{C}^1; D=0$

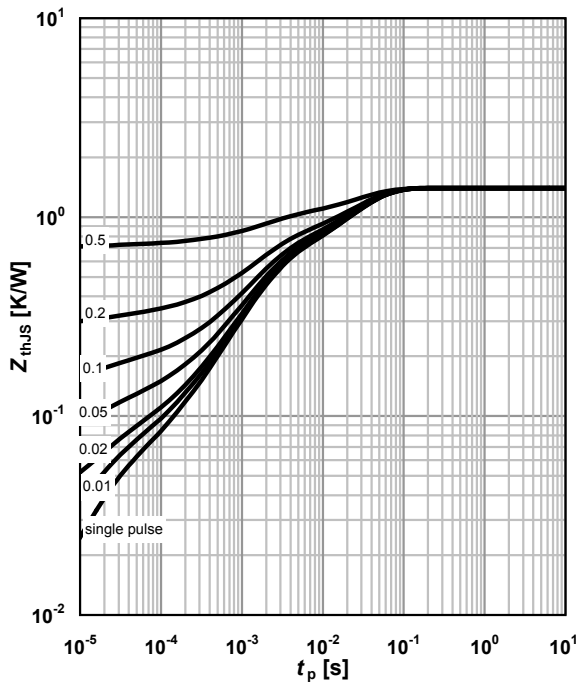
parameter: t_p



4 Max. transient thermal impedance

$Z_{thJS}=f(t_p)$

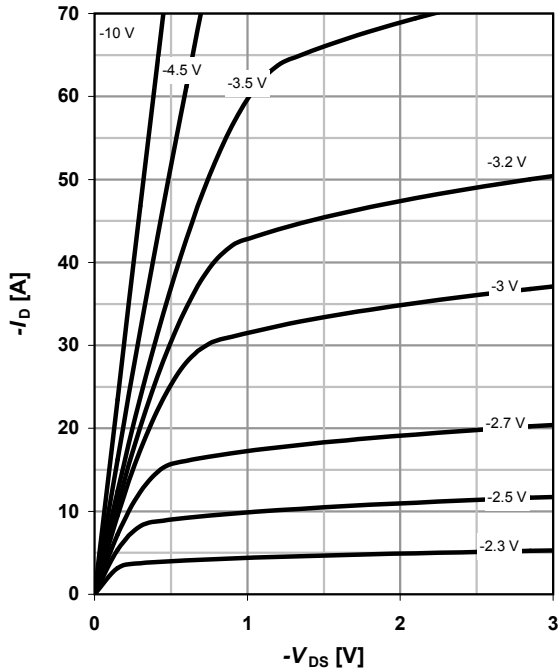
parameter: $D=t_p/T$



5 Typ. output characteristics

$I_D = f(V_{DS}); T_j = 25\text{ }^\circ\text{C}$

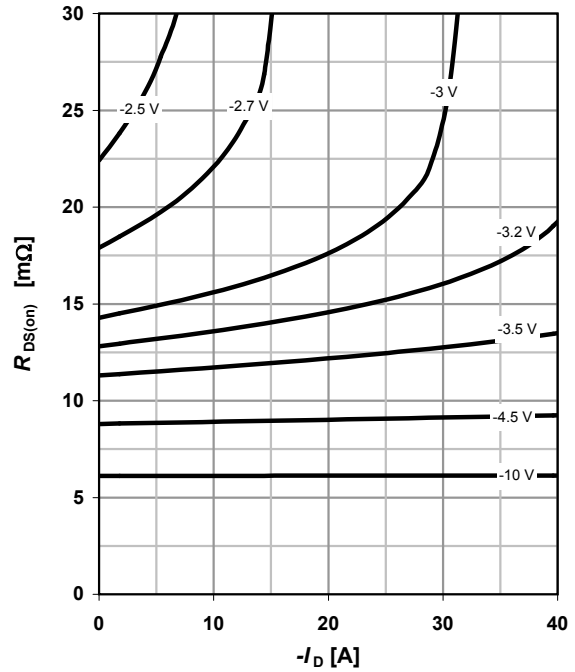
parameter: V_{GS}



6 Typ. drain-source on resistance

$R_{DS(on)} = f(I_D); T_j = 25\text{ }^\circ\text{C}$

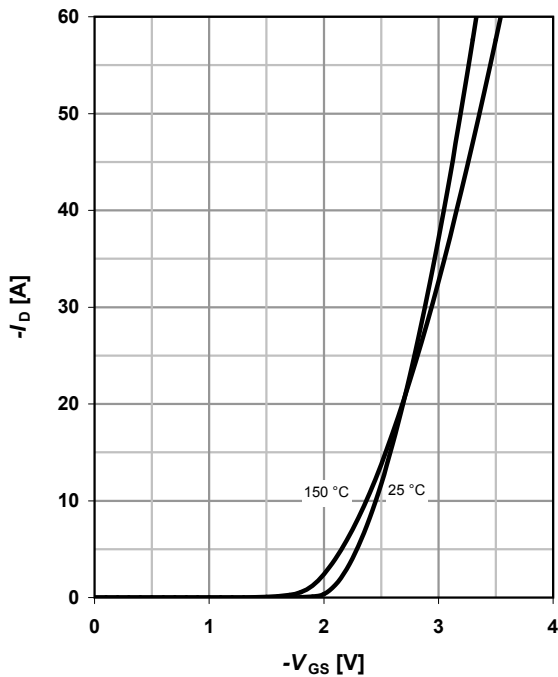
parameter: V_{GS}



7 Typ. transfer characteristics

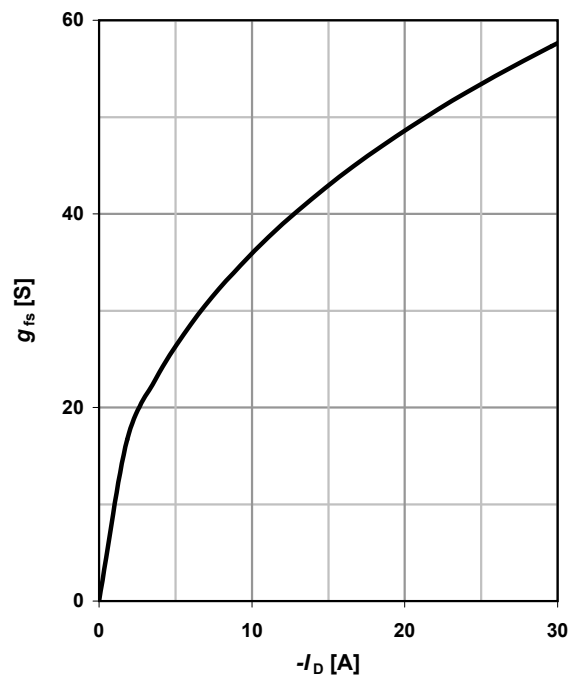
$I_D = f(V_{GS}); |V_{DS}| > 2|I_D|R_{DS(on)max}$

parameter: T_j



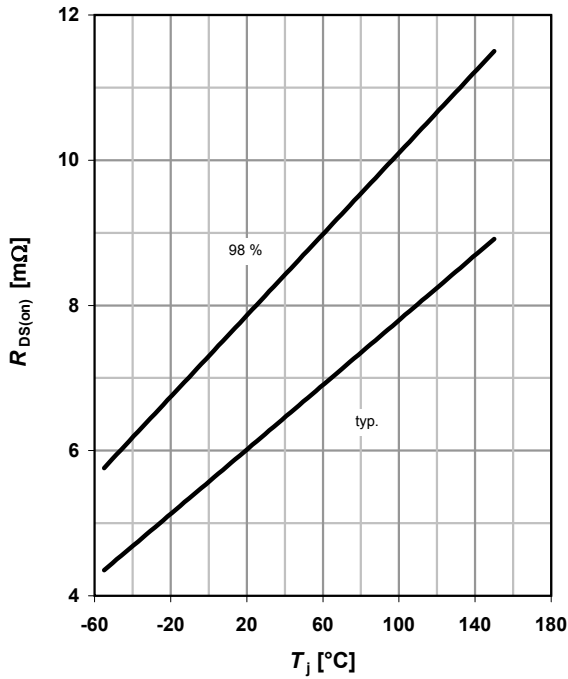
8 Typ. forward transconductance

$g_{fs} = f(I_D); T_j = 25\text{ }^\circ\text{C}$



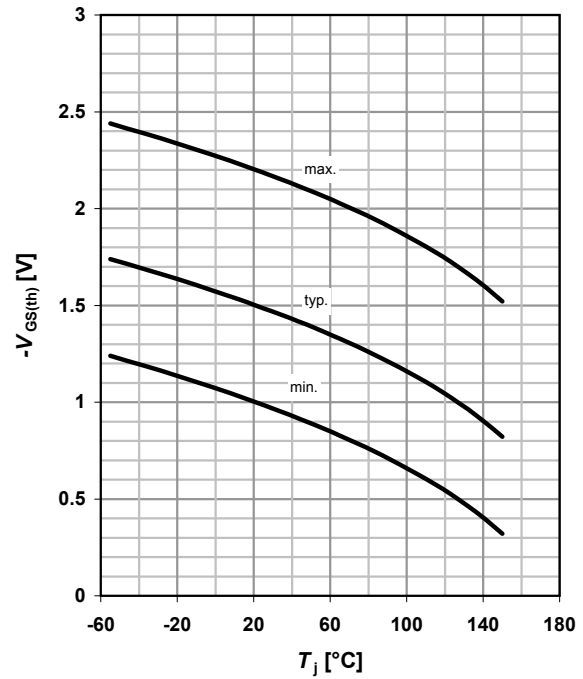
9 Drain-source on-state resistance

$R_{DS(on)} = f(T_j); I_D = -30 \text{ A}; V_{GS} = -10 \text{ V}$



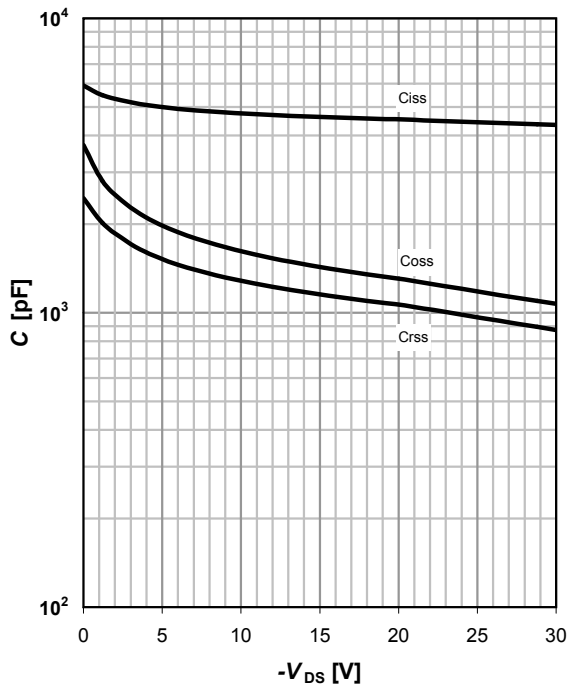
10 Typ. gate threshold voltage

$V_{GS(th)} = f(T_j); V_{GS} = V_{DS}; I_D = -250 \mu\text{A}$



11 Typ. capacitances

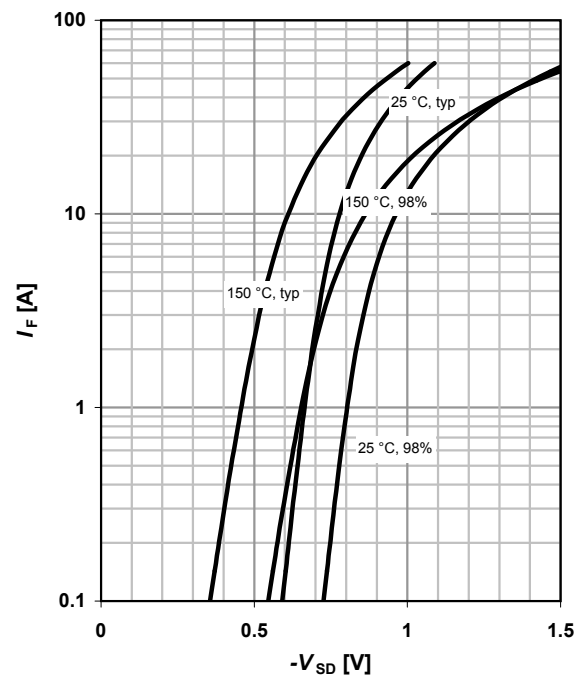
$C = f(V_{DS}); V_{GS} = 0 \text{ V}; f = 1 \text{ MHz}$



12 Forward characteristics of reverse diode

$I_F = f(V_{SD})$

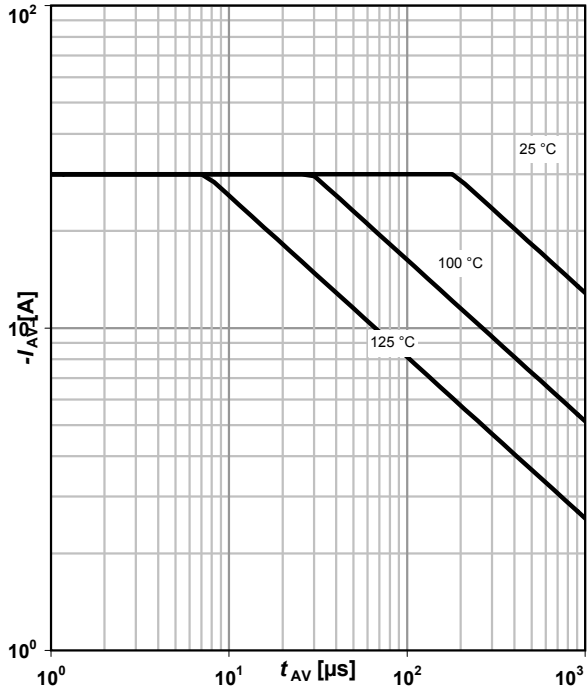
parameter: T_j



13 Avalanche characteristics

$I_{AS}=f(t_{AV}); R_{GS}=25 \Omega$

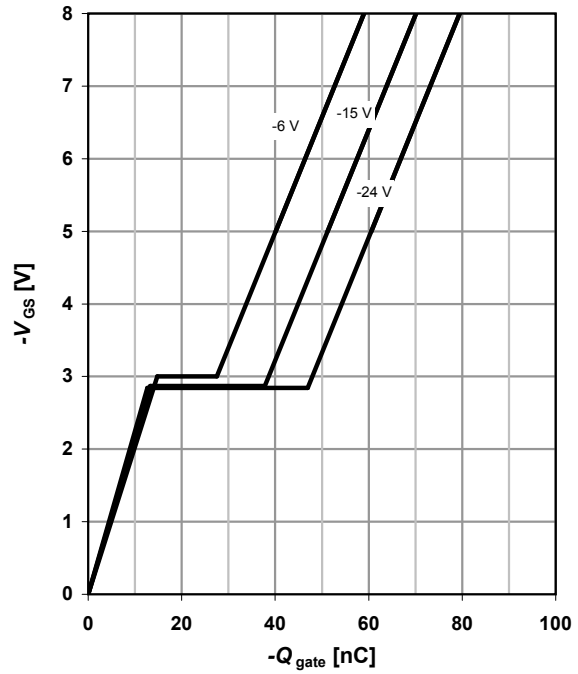
parameter: $T_{j(start)}$



14 Typ. gate charge

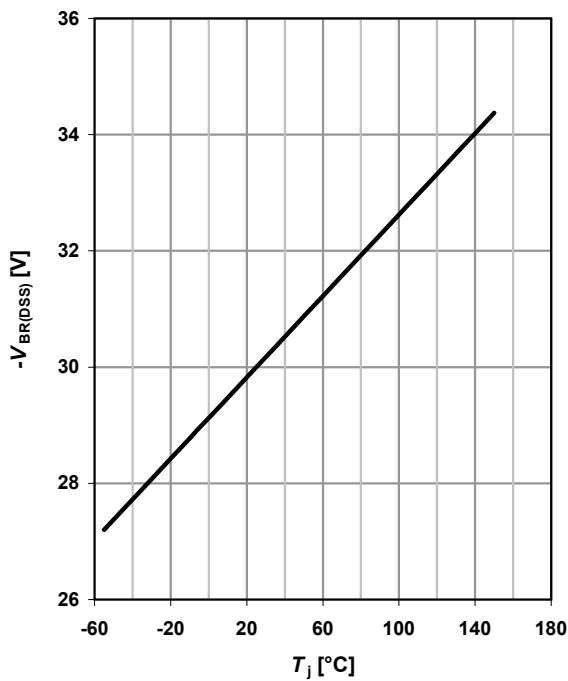
$V_{GS}=f(Q_{gate}); I_D=-30 \text{ A pulsed}$

parameter: V_{DD}

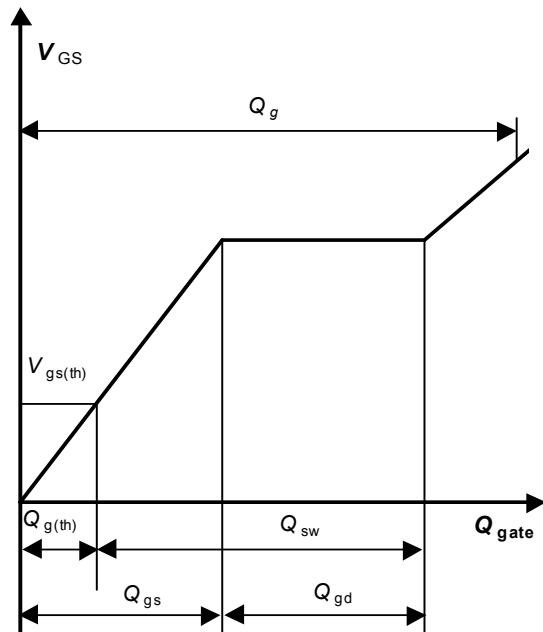


15 Drain-source breakdown voltage

$V_{BR(DSS)}=f(T_j); I_D=-250 \mu\text{A}$

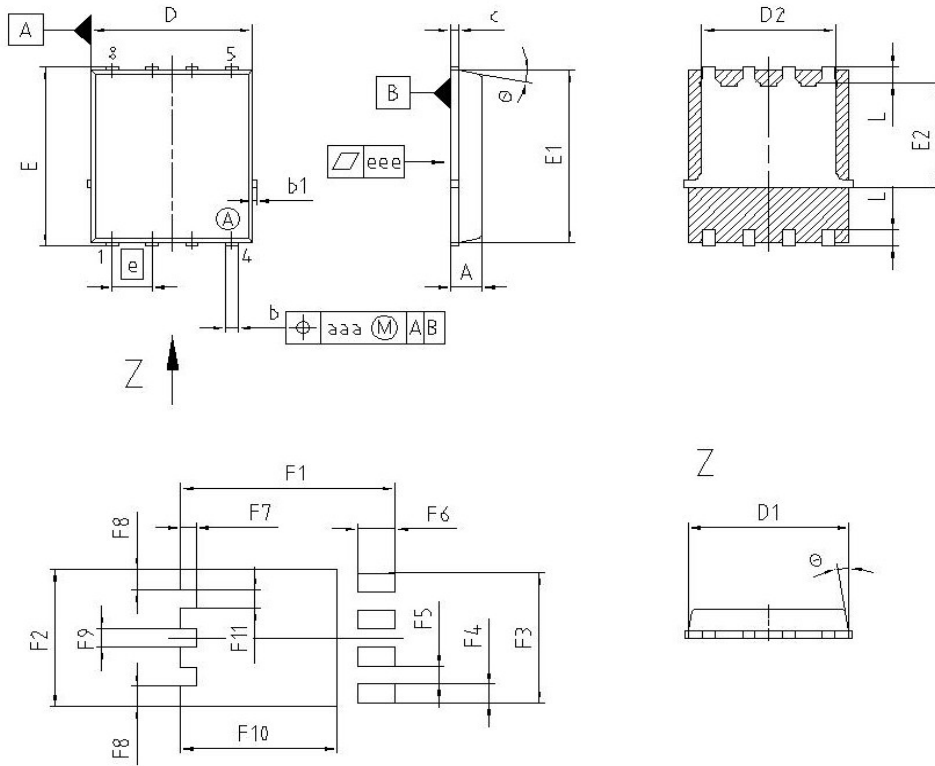


16 Gate charge waveforms



Package Outline

PG-TDSON-8: Outline



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	0.900	1.100	0.035	0.043
b	0.340	0.540	0.013	0.021
b1	0.000	0.120	0.000	0.005
c	0.150	0.350	0.006	0.014
D=D1	4.950	5.350	0.195	0.211
D2	4.200	4.400	0.165	0.173
E	5.950	6.350	0.234	0.250
E1	5.700	6.100	0.224	0.240
E2	3.400	3.800	0.134	0.150
e	1.270		0.050	
N	8		8	
L	0.450	0.650	0.018	0.026
ø	9°	11°	9°	11°
aaa	0.250		0.010	
eee	0.050		0.002	
F1	6.750	6.950	0.266	0.274
F2	4.600	4.800	0.181	0.189
F3	4.360	4.560	0.172	0.180
F4	0.550	0.750	0.022	0.030
F5	0.520	0.720	0.020	0.028
F6	1.100	1.300	0.043	0.051
F7	0.400	0.600	0.016	0.024
F8	0.600	0.800	0.024	0.031
F9	0.530	0.730	0.021	0.029
F10	4.900	5.100	0.193	0.201
F11	0.535	0.735	0.021	0.029

REFERENCE
JEDEC / MO-240

SCALE

EUROPEAN PROJECTION

ISSUE DATE
23-08-2006

FILE
TDSON_1

Dimensions in mm

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